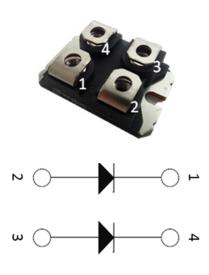


### 1700V SiC SBD Parallel

### **Power Module**



Parallel



### $V_{RRM} = 1700V$ $I_{DAV} = 50A @T_C = 125^0C$

#### **Features**

- · SiC Schottky Diode
  - Zero reverse recovery
  - Zero forward recovery
  - Temperature Independent switching behavior
  - Positive temperature coefficient on V<sub>F</sub>
- Low stray inductance
- High junction temperature operation

### **Applications**

- Supplies for DC power equipment
- Rectifier for induction heating
- Welding equipment
- High temperature and rectifiers

#### **Benefits**

- Outstanding performance at high frequency operation
- Low losses and Low EMI noises
- Very rugged and easy mount
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive Tc of VF
- RoHS Compliant

### **Absolute Maximum Ratings** (T<sub>i</sub>=25°C unless otherwise specified)

| Parameters                           | Symbol           | Conditions                                      | Specifications    | Units |
|--------------------------------------|------------------|---|-------------------|-------|
| Maximum Reverse Voltage              | V <sub>RRM</sub> |   | 1700              | V     |
| Average Forward Current (per SBD)    | I <sub>DAV</sub> | $T_j = 25$ $^{\circ}$ C                         | 150               | Α     |
|                                      |                  | $T_j = 150^{\circ}C$                            | 50                | Α     |
| Non-repetitive Forward Surge Current | I <sub>FSM</sub> | $t=8.3 \text{ ms}, T_C = 150  ^{\circ}\text{C}$ | 200               | Α     |
|                                      |                  | $T=10 \mu s$ , $T_C = 25  {}^{0}C$              | 800               | Α     |
| Operating Junction Temperature       | T <sub>j</sub>   |   | -55 ~ 175         | °C    |
| Storage Temperature                  | T <sub>STG</sub> |   | -55 ~ <b>1</b> 50 | °C    |

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### **Electrical Characteristics** (T<sub>i</sub>=25°C unless otherwise specified)

| Parameters                              | Symbol           | Conditions  | Min  | Тур  | Max  | Units |
|---|------------------|---|------|------|------|-------|
| Maximum peak repetitive reverse voltage | V <sub>RRM</sub> |   | 1700 |      |      | V     |
| Maximum Reverse Leakage Current         | I <sub>RM</sub>  | $V_R = 1700V, T_j = 25^{0}C$                                    |      | 120  | 750  | μΑ    |
|   |                  | $V_R = 1700V, T_j = 150$ °C                                     |      | 250  | 1600 | μΑ    |
| Diode Forward Voltage                   | V <sub>F</sub>   | $I_F = 50A, T_j = 25$ °C  |      | 1.6  | 1.9  | V     |
|   |                  | $I_F = 50A, T_j = 150$ °C                                       |      | 2.5  | 2.8  | V     |
| Total Capacitive Charge                 | $Q_C$            | $V_R=1700 \text{ V}, I_F < I_{F,max}, T_j = 25  {}^{0}\text{C}$ |      | 370  |      | nC    |
| Switching Time                          | t <sub>C</sub>   | $dI_F/dt = 200 A/\mu s$ , $T_j = 150  {}^{0}C$                  |      |      | 10   | ns    |
| Total Capacitance                       | С                | V <sub>R</sub> = 0V, f = 1 MHz                                  |      | 4240 |      | pF    |
|   |                  | V <sub>R</sub> = 550V, f = 1 MHz                                |      | 240  |      | pF    |
|   |                  | V <sub>R</sub> = 1100V, f = 1 MHz                               |      | 235  |      | pF    |

### Thermal and Package Characteristics (T<sub>j</sub>=25°C unless otherwise specified)

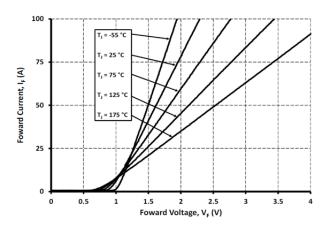
| Parameters                                | Symbol            | Conditions                                | Min  | Тур | Max  | Units |
|---|-------------------|---|------|-----|------|-------|
| Junction to Case Thermal Resistance       | R <sub>THJC</sub> | Per Diode                                 |      |     | 0.27 | °C /W |
| Junction to Ambient Thermal<br>Resistance | R <sub>THJA</sub> | Per Diode                                 |      |     | 20   | °C /W |
| Mounting Torque                           | M <sub>d</sub>    |   |      |     | 1.5  | N-m   |
| Terminal Connection Torque                | M <sub>dt</sub>   |   | 1.3  |     | 1.5  | N-m   |
| Package Weight                            | W <sub>t</sub>    |   |      | 32  |      | g     |
| Isolation Voltage                         | V <sub>ISOL</sub> | I <sub>ISOL</sub> < 1mA, 50/60Hz, t=1 min | 2500 | V   |      |       |

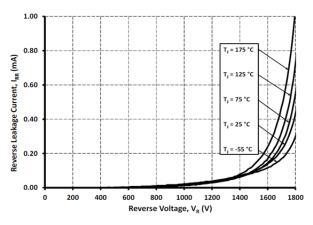
### **Product Number and Descriptions**

| Part Number     | Rating     | Pin 1     | Pin 2   | Pin 3   | Pin 4     |
|-----------------|------------|-----------|---------|---------|-----------|
| GHXS050A170S-D3 | 1700V, 40A | Cathode 1 | Anode 1 | Anode 2 | Cathode 2 |

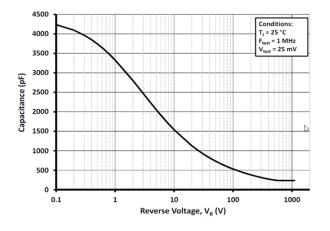
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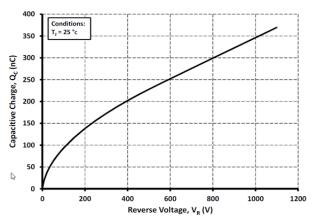




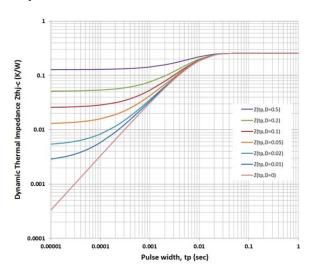
### Forward Characteristics vs. Junction Temperature



Reverse Characteristics vs. Junction Temperature



### Capacitance Curve vs. Reverse Bias



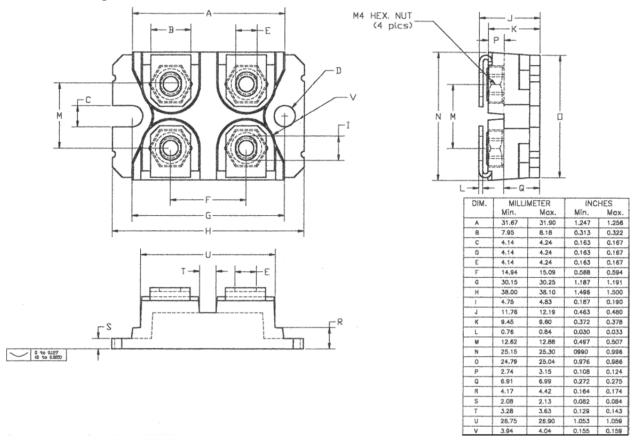
Recovery Charge vs. Reverse Voltage

**Dynamic Thermal Resistance** 

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### **SOT-227 Package Outline**



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### **Revision History**

| Date       | Revision | Notes                       |
|------------|----------|-----------------------------|
| 1/25/2017  | 0.1      | Initial release             |
| 01/03/2020 | 0.2      | Applied company name change |

#### Notes

#### **RoHS Compliance**

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented March, 2013. RoHS Declarations for this product can be obtained from the Product Documentation sections of www.SemiQ.com.

#### **REACh Compliance**

REACh substances of high concern (SVHC) information is available for this product. Since the European Chemicals Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact our office at SemiQ Headquarters in Lake Forest, California to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

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|-----------------------------------|--------------------------|----------------|---------------|---|---------------------|---------------|---------------------------|---------------------------|
| <u>25.163.2453.0</u> <u>25.16</u> | 63.4253.0 25.            | 190.2053.0     | 25.194.3453.0 | 25.320.4853.1                           | 25.320.5253.1       | 25.326.3253.1 | 25.326.3553.1             | 25.330.1653.1             |
| <u>25.330.4753.1</u> <u>25.33</u> | 30.5253.1 25.            | 334.3253.1     | 25.334.3353.1 | 25.350.2053.0                           | 25.352.4753.1       | 25.522.3253.0 | <u>T483C</u> <u>T484C</u> | <u>T485F</u> <u>T485H</u> |
| T512F-YEB T513F                   | T514F T554               | <u>T612FSE</u> | 25.161.3453.0 | 25.179.2253.0                           | 25.194.3253.0       | 25.325.1253.1 | 25.326.4253.1             | 25.330.0953.1             |
| <u>25.332.4353.1</u> <u>25.35</u> | 50.1653.0 25.            | 350.2453.0     | 25.352.1453.0 | 25.352.1653.0                           | 25.352.2453.0       | 25.352.5453.1 | 25.522.3353.0             | 25.602.4053.0             |
| 25.640.5053.0                     |                          |                |               |   |                     |               |                           |                           |